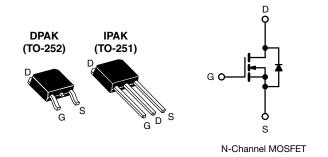


Vishay Siliconix

Power MOSFET



PRODUCT SUMMARY					
V _{DS} (V)	100				
R _{DS(on)} (Ω)	$V_{GS} = 10 V$ 0.27				
Q _g max. (nC)	16				
Q _{gs} (nC)	4.4				
Q _{gd} (nC)	7.7				
Configuration	Single				

FEATURES

- Dynamic dV/dt rating
- Repetitive avalanche rated
- Surface-mount (IRFR120, SiHFR120)
- Straight lead (IRFU120, SiHFU120)
- Available in tape and reel
- Fast switching
- Ease of paralleling
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The DPAK is designed for surface mounting using vapor phase, infrared, or wave soldering techniques. The straight lead version (IRFU, SiHFU series) is for through-hole mounting applications. Power dissipation levels up to 1.5 W are possible in typical surface mount applications.

ORDERING INFORMATION							
PACKAGE	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	IPAK (TO-251)		
Lood (Db) from	SiHFR120-GE3	SiHFR120TR-GE3 a	SiHFR120TRR-GE3 a	SiHFR120TRL-GE3 a	SiHFU120-GE3		
Lead (Pb)-free and halogen-free	IRFR120PbF-BE3 ^b	IRFR120TRPbF-BE3 ab	IRFR120TRRPbF-BE3 ab	IRFR120TRLPbF-BE3 ab	-		
Lead (Pb)-free	IRFR120PbF	IRFR120TRPbF ^a	IRFR120TRRPbF ^a	IRFR120TRLPbF ^a	IRFU120PbF		

Notes

a. See device orientation

b. "-BE3" denotes alternate manufacturing location

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage	V _{DS}	100	v		
Gate-source voltage	V _{GS}	± 20	v		
Continuous drain current	L.	7.7	А		
	ID	4.9			
Pulsed drain current ^a	I _{DM}	31			
Linear derating factor	0.33	0.33	— W/°C		
Linear derating factor (PCB mount) e		0.020			
Single pulse avalanche energy ^b		E _{AS}	210	mJ	
Repetitive avalanche Current ^a			I _{AR}	7.7	А
Repetitive avalanche Energy ^a			E _{AR}	4.2	mJ
Maximum power dissipation	25 °C	P 42		W	
Maximum power dissipation (PCB mount) ^e	P _D	2.5	vv		
Peak diode recovery dV/dt c	dV/dt	5.5	V/ns		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C	
Soldering recommendations (peak temperature) ^d	for	10 s		260	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. $V_{DD} = 25 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 5.3 mH, $R_g = 25 \Omega$, $I_{AS} = 7.7 \text{ A}$ (see fig. 12).

c. $I_{SD} \leq 9.2$ A, dI/dt ≤ 110 A/µs, $V_{DD} \leq V_{DS}$, $T_J \leq 150$ °C.

d. 1.6 mm from case.

e. When mounted on 1" square PCB (FR-4 or G-10 material).

S21-0466-Rev. D, 17-May-2021



HALOGEN



THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R _{thJA}	-	-	110		
Maximum junction-to-ambient (PCB mount) a	R _{thJA}	-	-	50	°C/W	
Maximum junction-to-case (drain)	R _{thJC}	-	-	3.0		

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static		•					
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$		100	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.13	-	V/°C
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μΑ	2.0	-	4.0	V
Gate-source leakage	I _{GSS}	,	V _{GS} = ± 20 V	-	-	± 100	nA
Zeve este veltere ducie comont		V _{DS} = 100 V, V _{GS} = 0 V		-	-	25	
Zero gate voltage drain current	IDSS	V _{DS} = 80 V	, V _{GS} = 0 V, T _J = 125 °C	-	-	250	μA
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 4.6 A ^b	-	-	0.27	Ω
Forward transconductance	9 _{fs}	V _{DS} :	= 50 V, I _D = 4.6 A	1.6	-	-	S
Dynamic							
Input capacitance	C _{iss}		$V_{GS} = 0 V,$	-	360	-	
Output capacitance	C _{oss}		$V_{DS} = 25 V,$	-	150	-	pF
Reverse transfer capacitance	C _{rss}	f = 1.	.0 MHz, see fig. 5	-	34	-	1
Total gate charge	Qg			-	-	16	1
Gate-source charge	Q _{gs}	V _{GS} = 10 V	I _D = 9.2 A, V _{DS} = 80 V, see fig. 6 and 13 ^b	-	-	4.4	nC
Gate-drain charge	Q _{gd}		see lig. o and to		-	7.7	
Turn-on delay time	t _{d(on)}			-	6.8	-	1
Rise time	t _r	V _{DD} =	= 50 V, I _D = 9.2 A,	-	27	-	
Turn-off delay time	t _{d(off)}	$R_g = 18 \Omega$,	$R_D = 5.2 \Omega$, see fig. 10 ^b	-	18	-	ns
Fall time	t _f			-	17	-	1
Internal drain inductance	Rg	f = 1	MHz, open drain	1.0	-	5.0	Ω
Internal source inductance	L _D	Between lead	۰ لم	-	4.5	-	
Input capacitance	L _S	6 mm (0.25") package and die contact		-	7.5	-	nH
Drain-source body diode characteristics							
Continuous source-drain diode current	ا _S	MOSFET sy showing the	ymbol	-	-	7.7	
Pulsed diode forward current ^a	I _{SM}	integral revers		-	-	31	A
Body diode voltage	V _{SD}	T _J = 25 °C	, $I_{\rm S}$ = 7.7 A, $V_{\rm GS}$ = 0 V ^b	-	-	2.5	V
Body diode reverse recovery time	t _{rr}	T _ 05 °C I	- 0 0 0 dl/dt 100 0/b	-	130	260	ns
Body diode reverse recovery charge	Q _{rr}	$I_{\rm J} = 25 {}^{-}\rm{C}, I_{\rm F}$	= 9.2 A, dl/dt = 100 A/µs ^b	-	0.65	1.3	μC
Forward turn-on time	t _{on}	Intrinsic tu	rn-on time is negligible (turr	-on is doi	minated b	by L_{S} and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

2



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

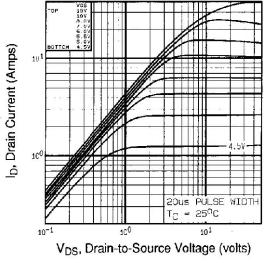


Fig. 1 - Typical Output Characteristics, $T_C = 25 \ ^{\circ}C$

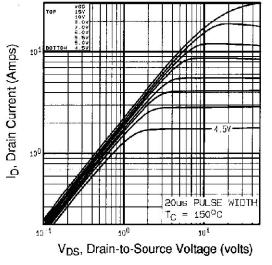


Fig. 2 - Typical Output Characteristics, $T_C = 150$ °C

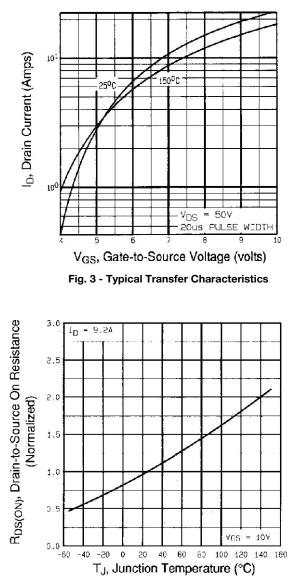


Fig. 4 - Normalized On-Resistance vs. Temperature

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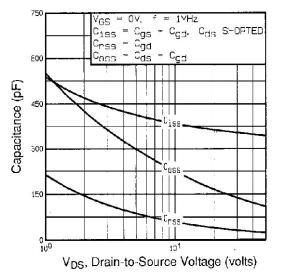


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

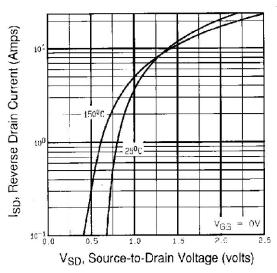


Fig. 7 - Typical Source-Drain Diode Forward Voltage

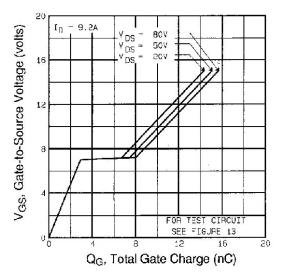


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

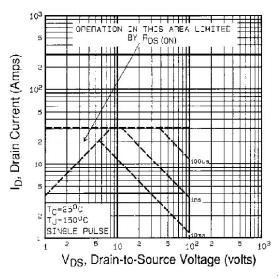


Fig. 8 - Maximum Safe Operating Area

4



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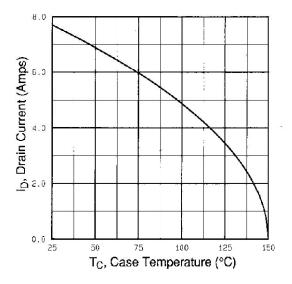


Fig. 9 - Maximum Drain Current vs. Case Temperature

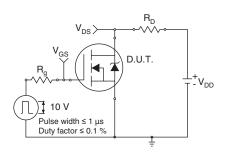


Fig. 10a - Switching Time Test Circuit

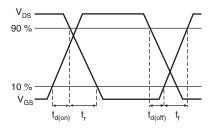


Fig. 10b - Switching Time Waveforms

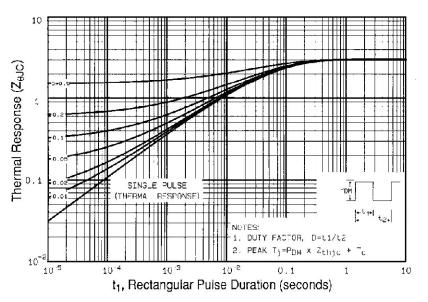


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



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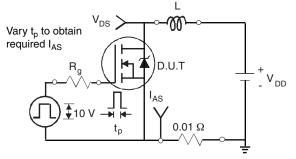


Fig. 12a - Unclamped Inductive Test Circuit

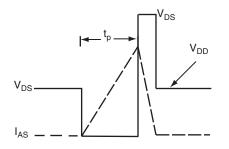


Fig. 12b - Unclamped Inductive Waveforms

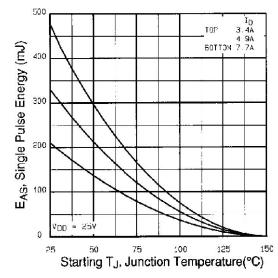


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

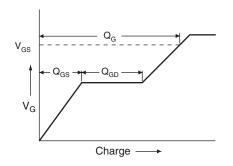
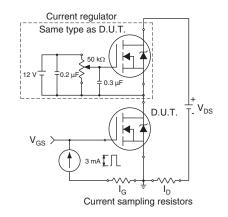


Fig. 13a - Basic Gate Charge Waveform

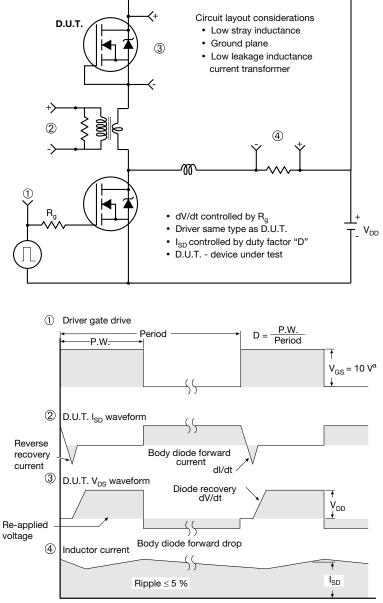




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Note

a. $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel

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TO-252AA Case Outline

VERSION 1: FACILITY CODE = Y







	MILLIMETERS			
DIM.	MIN.	MAX.		
А	2.18	2.38		
A1	-	0.127		
b	0.64	0.88		
b2	0.76	1.14		
b3	4.95	5.46		
С	0.46	0.61		
C2	0.46	0.89		
D	5.97	6.22		
D1	4.10	-		
E	6.35	6.73		
E1	4.32	-		
Н	9.40	10.41		
е	2.28	BSC		
e1	4.56	BSC		
L	1.40	1.78		
L3	0.89	1.27		
L4	-	1.02		
L5	1.01	1.52		

Note

• Dimension L3 is for reference only



VERSION 2: FACILITY CODE = N



	MILLIMETERS				
DIM.	MIN.	MAX.			
A	2.18	2.39			
A1	-	0.13			
b	0.65	0.89			
b1	0.64	0.79			
b2	0.76	1.13			
b3	4.95	5.46			
С	0.46	0.61			
c1	0.41	0.56			
c2	0.46	0.60			
D	5.97	6.22			
D1	5.21	-			
E	6.35	6.73			
E1	4.32	-			
е	2.29	BSC			
Н	9.94	10.34			

	MILLIMETERS				
DIM.	MIN.	MAX.			
L	1.50	1.78			
L1	2.74	l ref.			
L2	0.51	BSC			
L3	0.89	1.27			
L4	-	1.02			
L5	1.14	1.49			
L6	0.65	0.85			
θ	0°	10°			
θ1	0°	15°			
θ2	25°	35°			

Notes

• Dimensioning and tolerance confirm to ASME Y14.5M-1994

• All dimensions are in millimeters. Angles are in degrees

• Heat sink side flash is max. 0.8 mm

Radius on terminal is optional

ECN: E19-0649-Rev. Q, 16-Dec-2019 DWG: 5347



TO-251AA (HIGH VOLTAGE)



	MILLI	METERS	INC	HES		MILLI	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.	DIM.	MIN.	MAX.	MIN.	MA
А	2.18	2.39	0.086	0.094	D1	5.21	-	0.205	-
A1	0.89	1.14	0.035	0.045	E	6.35	6.73	0.250	0.2
b	0.64	0.89	0.025	0.035	E1	4.32	-	0.170	-
b1	0.65	0.79	0.026	0.031	е	2.29	BSC	2.29	BSC
b2	0.76	1.14	0.030	0.045	L	8.89	9.65	0.350	0.3
b3	0.76	1.04	0.030	0.041	L1	1.91	2.29	0.075	0.0
b4	4.95	5.46	0.195	0.215	L2	0.89	1.27	0.035	0.0
с	0.46	0.61	0.018	0.024	L3	1.14	1.52	0.045	0.0
c1	0.41	0.56	0.016	0.022	θ1	0'	15'	0'	15
c2	0.46	0.86	0.018	0.034	θ2	25'	35'	25'	35
D	5.97	6.22	0.235	0.245		•	•	•	

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimension are shown in inches and millimeters.
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.13 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.
- 4. Thermal pad contour optional with dimensions b4, L2, E1 and D1.
- 5. Lead dimension uncontrolled in L3.
- 6. Dimension b1, b3 and c1 apply to base metal only.
- 7. Outline conforms to JEDEC outline TO-251AA.



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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